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APPLICATION NO.	NO. FILING DATE		FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/940,792	08/29/2001		Paul A. Farrar	M4065.0382/P382-A	5268	
24998	7590	04/25/2005		EXAMINER		
		RO MORIN & OS	LEE, EUGENE			
2101 L Stree Washington,		37		ART UNIT	PAPER NUMBER	
				2815	<del></del>	
			DATE MAILED: 04/25/2005			

Please find below and/or attached an Office communication concerning this application or proceeding.

## Advisory Action Before the Filing of an Appeal Brief

Application No.	Applicant(s)		
09/940,792	FARRAR ET AL.		
Examiner	Art Unit		
Eugene Lee	2815		

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	Eugene Lee	2815						
The MAILING DATE of this communication appears on the cover sheet with the correspondence address								
THE REPLY FILED 07 April 2005 FAILS TO PLACE THIS APPLICATION IN CONDITION FOR ALLOWANCE.								
1. The reply was filed after a final rejection, but prior to or on the same day as filing a Notice of Appeal. To avoid abandonment of this application, applicant must timely file one of the following replies: (1) an amendment, affidavit, or other evidence, which places the application in condition for allowance; (2) a Notice of Appeal (with appeal fee) in compliance with 37 CFR 41.31; or (3) a Request for Continued Examination (RCE) in compliance with 37 CFR 1.114. The reply must be filed within one of the following time periods:								
a) The period for reply expires 3 months from the mailing date of the final rejection.  The period for reply expires on: (1) the mailing date of this Advisory Action, or (2) the date set forth in the final rejection, whichever is later. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of the final rejection.  Examiner Note: If box 1 is checked, check either box (a) or (b). ONLY CHECK BOX (b) WHEN THE FIRST REPLY WAS FILED WITHIN TWO MONTHS OF THE FINAL REJECTION. See MPEP 706.07(f).								
Extensions of time may be obtained under 37 CFR 1.136(a). The date on which the petition under 37 CFR 1.136(a) and the appropriate extension fee have been filed is the date for purposes of determining the period of extension and the corresponding amount of the fee. The appropriate extension fee under 37 CFR 1.17(a) is calculated from: (1) the expiration date of the shortened statutory period for reply originally set in the final Office action; or (2) as set forth in (b) above, if checked. Any reply received by the Office later than three months after the mailing date of the final rejection, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).  NOTICE OF APPEAL								
2. The Notice of Appeal was filed on A brief in compliance with 37 CFR 41.37 must be filed within two months of the date of filing the Notice of Appeal (37 CFR 41.37(a)), or any extension thereof (37 CFR 41.37(e)), to avoid dismissal of the appeal. Since a Notice of Appeal has been filed, any reply must be filed within the time period set forth in 37 CFR 41.37(a).  AMENDMENTS								
3. The proposed amendment(s) filed after a final rejection, but prior to the date of filing a brief, will <u>not</u> be entered because  (a) They raise new issues that would require further consideration and/or search (see NOTE below);  (b) They raise the issue of new matter (see NOTE below);								
(c) They are not deemed to place the application in better form for appeal by materially reducing or simplifying the issues for appeal; and/or								
(d) They present additional claims without canceling a corresponding number of finally rejected claims.  NOTE: (See 37 CFR 1.116 and 41.33(a)).								
4. The amendments are not in compliance with 37 CFR 1.121. See attached Notice of Non-Compliant Amendment (PTOL-324).								
<ul> <li>5. Applicant's reply has overcome the following rejection(s):</li> <li>6. Newly proposed or amended claim(s) would be allowable if submitted in a separate, timely filed amendment canceling the non-allowable claim(s).</li> </ul>								
7. For purposes of appeal, the proposed amendment(s): a) will not be entered, or b) will be entered and an explanation of how the new or amended claims would be rejected is provided below or appended.  The status of the claim(s) is (or will be) as follows:  Claim(s) allowed:								
Claim(s) objected to:Claim(s) rejected: 46-48,51-56,58-60,62-65 and 67-81. Claim(s) withdrawn from consideration:								
AFFIDAVIT OR OTHER EVIDENCE  8. The affidavit or other evidence filed after a final action, but before or on the date of filing a Notice of Appeal will not be entered because applicant failed to provide a showing of good and sufficient reasons why the affidavit or other evidence is necessary and was not earlier presented. See 37 CFR 1.116(e).								
9. The affidavit or other evidence filed after the date of filing a Notice of Appeal, but prior to the date of filing a brief, will <u>not</u> be entered because the affidavit or other evidence failed to overcome <u>all</u> rejections under appeal and/or appellant fails to provide a showing a good and sufficient reasons why it is necessary and was not earlier presented. See 37 CFR 41.33(d)(1).								
10. The affidavit or other evidence is entered. An explanation of the status of the claims after entry is below or attached.  REQUEST FOR RECONSIDERATION/OTHER								
11. The request for reconsideration has been considered but does NOT place the application in condition for allowance because:  See Continuation Sheet:								
12. Note the attached Information Disclosure Statement(s).  13. Other:								
13. [ Other:								
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TOM THOMAS SUPERVISORY PATENT EXAMINER Continuation of 11. does NOT place the application in condition for allowance because: Regarding applicant's argument on page 11 that the conductive film 37 does not connect the buried conductor pattern with the exterior of the monocrystalline substrate, this argument is not persuasive. The conductive film 37 is on the top surface of the substrate 21, and is clearly exterior to the substrate. It is connected to the buried conductor pattern. Regarding the applicant's argument on page 12 that it would not have been obvious to combine Yamamoto with those of Yamagata, this argument is not persuasive. Yamagata discloses (see, for example, column 1, lines 51-53) a monocrystalline silicon substrate and discloses the monocrystalline substrate having good controllability of crystal orientation and very less crystal defects. Clearly, it would have been obvious to one of ordinary skill in the art to modify Yamamoto by having a monocrystalline substrate in order to have good controllability of crystal orientation and very less crystal defects. Whether Yamagata discloses a "buried conductor pattern being completely surrounded by a monocrystalline material" like Yamamoto is not relevant since Yamagata clearly discloses that a monocrystalline substrate has good controllability of crystal orientation and very less crystal defects, characteristics that indisputably would be beneficial to any substrate in a semiconductor device.